

ltem	Performance	Test Condition		
Electrical Performance	Test			
Inductance	Refer to standard electrical	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.		
DCR	characteristics list.	CH16502,Agilent33420A Micro-Ohm Mete		
Operating Temperature	-55 $^\circ\!\!\mathbb{C}$ ~+155 $^\circ\!\!\mathbb{C}$ (Including self - temperature	rise)		
Storage temperature and Humidity range	110~+40℃,50~60%RH (Product with tapin 255~+155℃(on board)	g)		
Saturation Current (Isat1)	Approximately $ riangle$ L30%	Saturation DC Current (Isat) will cause L0 to drop $ riangle$ L(%)		
Heat Rated Current (Irms)	Approximately $ riangle T40^\circ\!\mathbb{C}$	Heat Rated Current (Irms) will cause the coil temperature rise $\triangle T(^{\circ}C)$. 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer		
Reliability Test				
High Temperature Exposure(Storage) AEC-Q200		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Temperature : 155±2°C Duration : 1000hrs Min. Measured at room temperature after placing for 24±2 hrs		
Temperature Cycling AEC-Q200	Appearance : No damage. Impedance : within±15% of initial value	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Condition for 1 cycle Step1 : $-55\pm2^{\circ}C$ 30min Min. Step2 : $155\pm2^{\circ}C$ transition time 1min MAX. Step3 : $155\pm2^{\circ}C$ 30min Min. Step4 : Low temp. transition time 1min MAX. Number of cycles : 1000 Measured at room temperature after placing for 24±2 hrs		
Moisture Resistance	 Q: Shall not exceed the specification value. (IPC/JEDEC J-STD-020D Classification Reflow 1.Baked at 50°C for 25hrs, measured at room to after placing for 4 hrs. 2.Raise temperature to 65±2°C 90-100%RH in keep 3 hours, cool down to 25°C in 2.5hrs. 3.Raise temperature to 65±2°C 90-100%RH in keep 3 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 2 hours, cool down to 25°C in 2.5hrs, keep of 25°C 80-100%RH for 15min and vibr frequency of 10 to 55 Hz to 10 Hz, measure at temperature after placing for 1~2 hrs. Preconditioning: Run through IR reflow for 2 tin (IPC/JEDEC J-STD-020DClassification Reflow Humidity : 85±3% R.H, Temperature : 85°C ±2°C Duration : 1000hrs Min with 100% rated current. 	 2.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs,keep at 25°C for 2hrs then keep at -10°C for 3hrs 4.Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room 		
Biased Humidity (AEC-Q200)				



Item	Performance	Test Condition							
Reliability Test									
High Temperature Operational Life (AEC-Q200)	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value.	(IP Ten Dur	conditioning C/JEDEC J nperature : ation : 100 asured at ro	-S 15 00h	୮D-020D 5±2℃ rs Min. w	Classif	ication Re% rated c	eflov curre	w Profiles) ent.
External Visual	Appearance:No damage	Inspect device construction, marking and workmanship. Electrical Test not required.				manship.			
Physical Dimension	According to the product specification size measurement	According to the product specification size measurement			asurement				
Resistance to Solvents	Appearance:No damage.	Adc	d aqueous v	vas	h chemic	al - Ok	EM clear	n or	equivalent.
	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value	Туј	pe Peak val (g's)	ue	Norm duration (I		Wave form	cha	Velocity ange (Vi)ft/sec
Mechanical Shock	Q : Shall not exceed the specification value.	SN					Half-sine		12.3
	RDC : within ±15% of initial value and shall not exceed the specification value.		Lead1006Half-sine12.3shocks in each direction along 3 perpendicular axes.						
Vibration		Osc Equ Tota Tes		que /ibr e:1 12 8 or	ency: 10∼ ation che .52mm±1	~2K~1 cker 0% 0 minut	0Hz for 2	20 m	ninute
Resistance to Soldering Heat	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value.	Т	emperature(* 260±5	c)	Time(s) 10±1	ramp/ and er	nperature /immersion nersion rat /s ±6 mm/	te	Number of heat cycles 1
Thermal shock (AEC-Q200)	RDC : within ±15% of initial value and shall not exceed the specification value.	Pre (IP Cor Ste Ste Nur	(solder temp conditioning C/JEDEC J ndition for 1 p1 : -55±2° p2 : 155±2 p3 : 155±2 nber of cyc asured at ro	g: F I-S ⁻ ເງ ເງ ໃດ ໃດ ໃດ ໃດ ໃດ ໃດ	TD-020D cle 5±1min within 208 15±1min : 300	Classif Sec.	ication R	eflov	w Profiles)



Item	Performance	Test Condition
Reliability Test		
ESD	Appearance : No damage.	P 00% 10% t _r Time (ns)
Solderability	More than 95% of the terminal electrode should be covered with solder ∘	a. Method B, 4 hrs @155°C dry heat @235°C±5°C b. Method B @ 215°C±5°C category 3.(8hours ± 15 min) c. Method D category 3. (8hours ± 15 min)@ 260°C±°C Preheat: 150°C,60sec. Solder: Sn96.5% Ag3% Cu0. 5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec. Depth: completely cover the termination
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation
Flammability	Electrical Test not required	V-0 or V-1 are acceptable.
Board Flex	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board. Support Solder Chip Printed circuit board before testing total the state of the section of the secti



Item	Performance	Test Condition
Reliability Test		
Terminal Strength (SMD)	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.

Note : When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition.



ltem	Performance	Test Condition		
Soldering and Mou	Inting			
Soldering		JANTEK terminations are suitable for all wave and g cannot be avoided, the preferred technique is the		
Lead Free Solder re-flow:	Recommended temperature profiles for re	-flow soldering in Figure 1.		
Soldering Iron (Figure 2):	limitations.	•		
() ⁽⁾ 	RE-HEATING SOLDERING NATURAL COOLING TP(260°C / 10s max.)	Iron Soldering PRE-HEATING SOLDERING NATURAL Within 4~5s		
	-180s 480s max. TIME(sec.)	Gradual cooling TIME(sec.)		
	Reflow times: 3 times max.	Iron Soldering times: 1 times max.		



Friendly reminder

- (1) When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition.
- (2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product.
- (3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use.
- (4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life.
- (5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition.
- (6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product.